IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Naoshi ADACHI

Serial No.:

to be assigned

Filed:

January 5, 2004

For:

HEAT TREATMENT JIG FOR SEMICONDUCTOR SUBSTRATE AND METHOD OF HEAT TREATING SEMICONDUCTOR FOR SUBSTRATE

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached form PTO-1449. It is respectfully requested that the references be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

Applicants respectfully submit that this disclosure is being made with the filing of the application, hence, no fee is required.

Respectfully submitted, CLARK & BRODY

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		Applicant: N	aohsi ADACHI et al.					
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	2003-037112	02/07/2003	Japan				x	
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	10-270369	10/09/1998	Japan				х	
	OTHER DOCUME	ENTS (Including	Author, Title, Date, Pertin	nent Pages	i, etc.)		Y Sun ranger	

Examiner:	Date Considered:					
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.						